

Supercurrent manipulation by Scanning Gate Microscopy in InSb nanoflag-based Josephson Junctions

Antonio Lombardi

Supervisors: Prof. S. Heun and Prof. L. Sorba

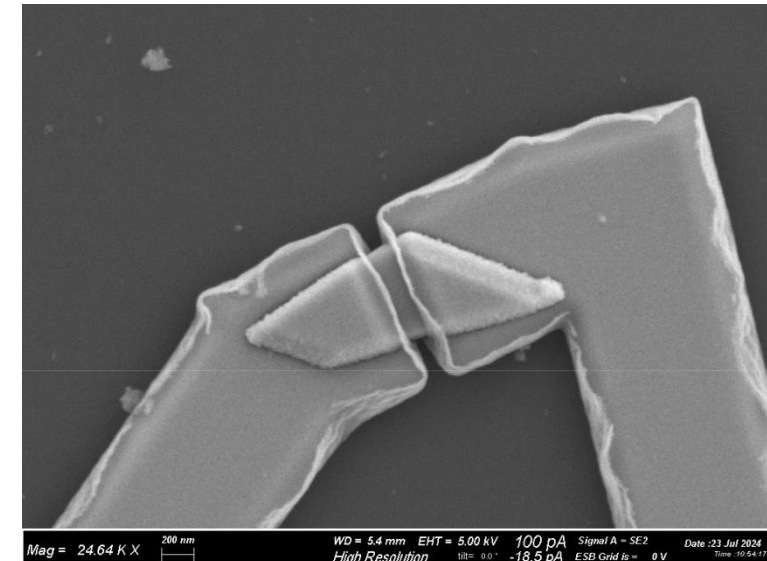
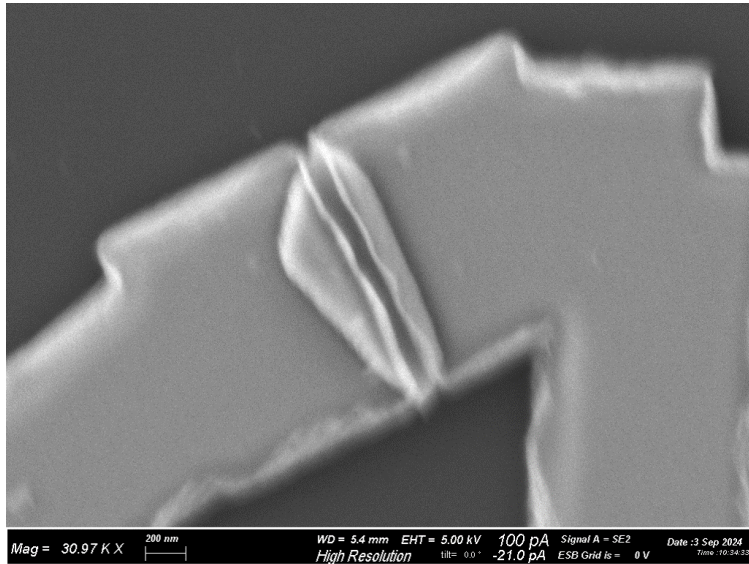
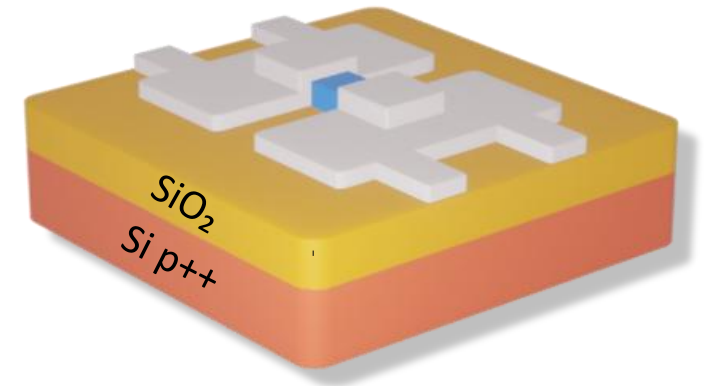


Outline

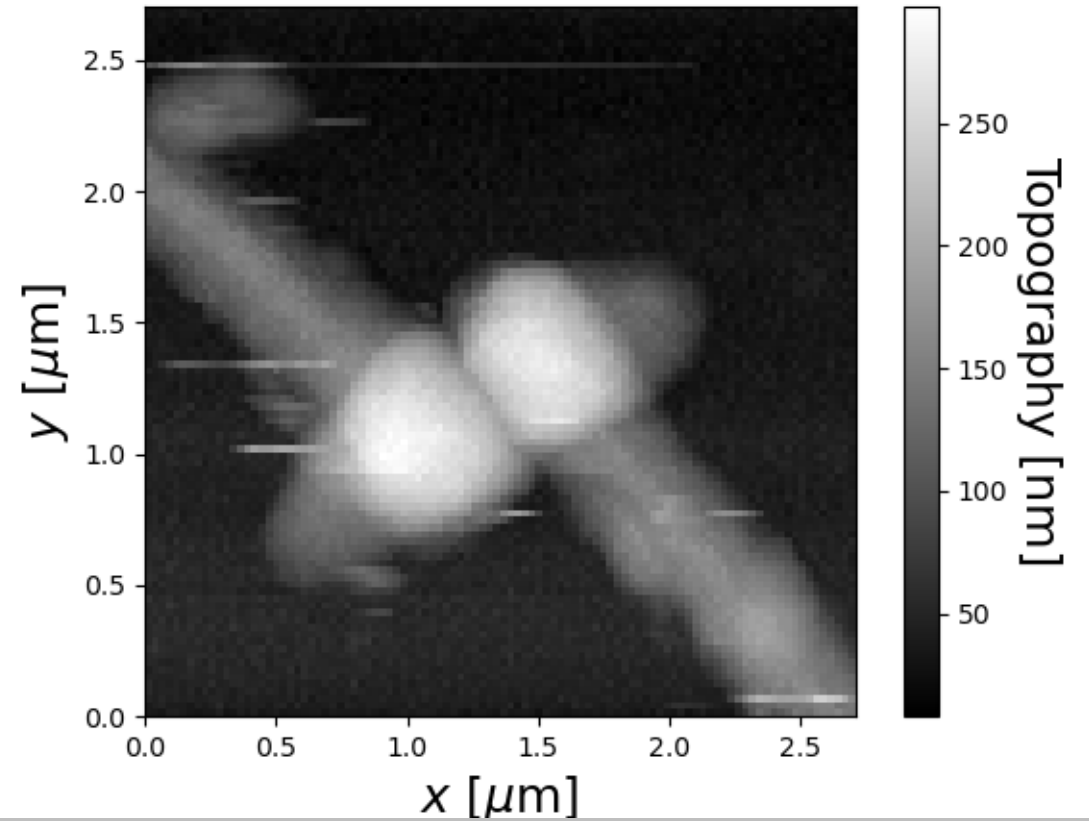
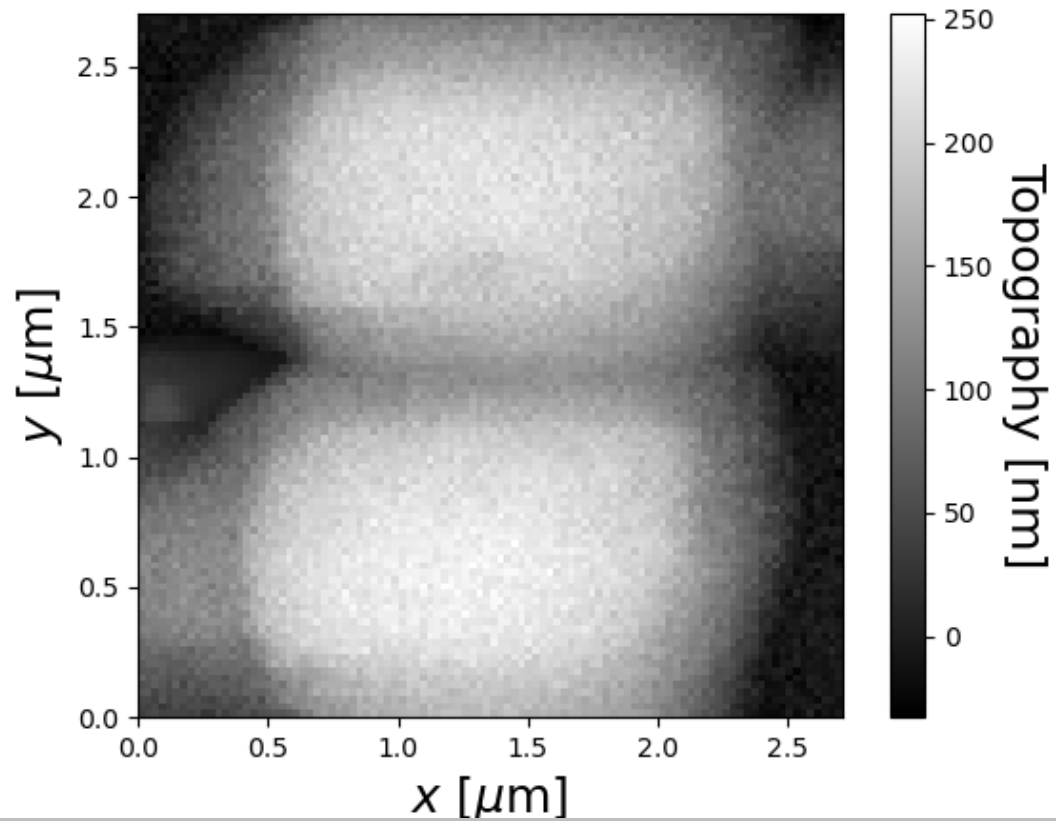
- First SGM maps of InSb nanoflag-based devices
- First measurements of tip-induced critical current modulation
- Observation of high interface transparency for InSb nanoflag-based devices

Nanoflag-based device nanofabrication

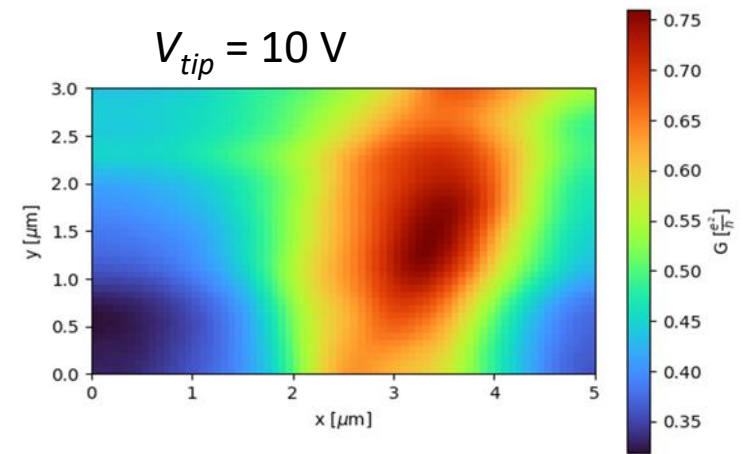
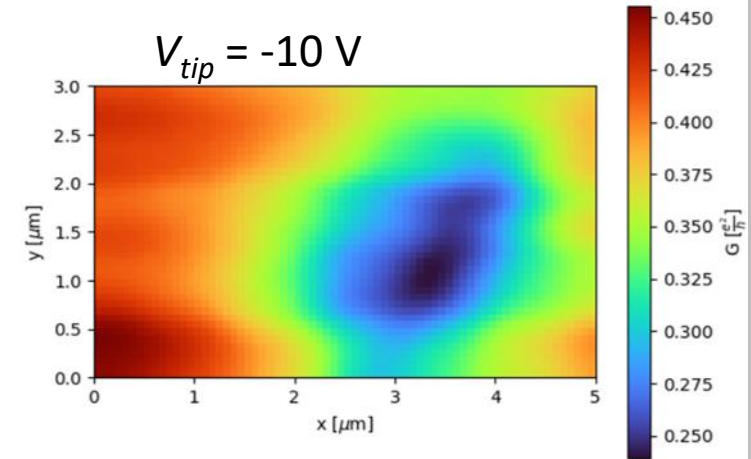
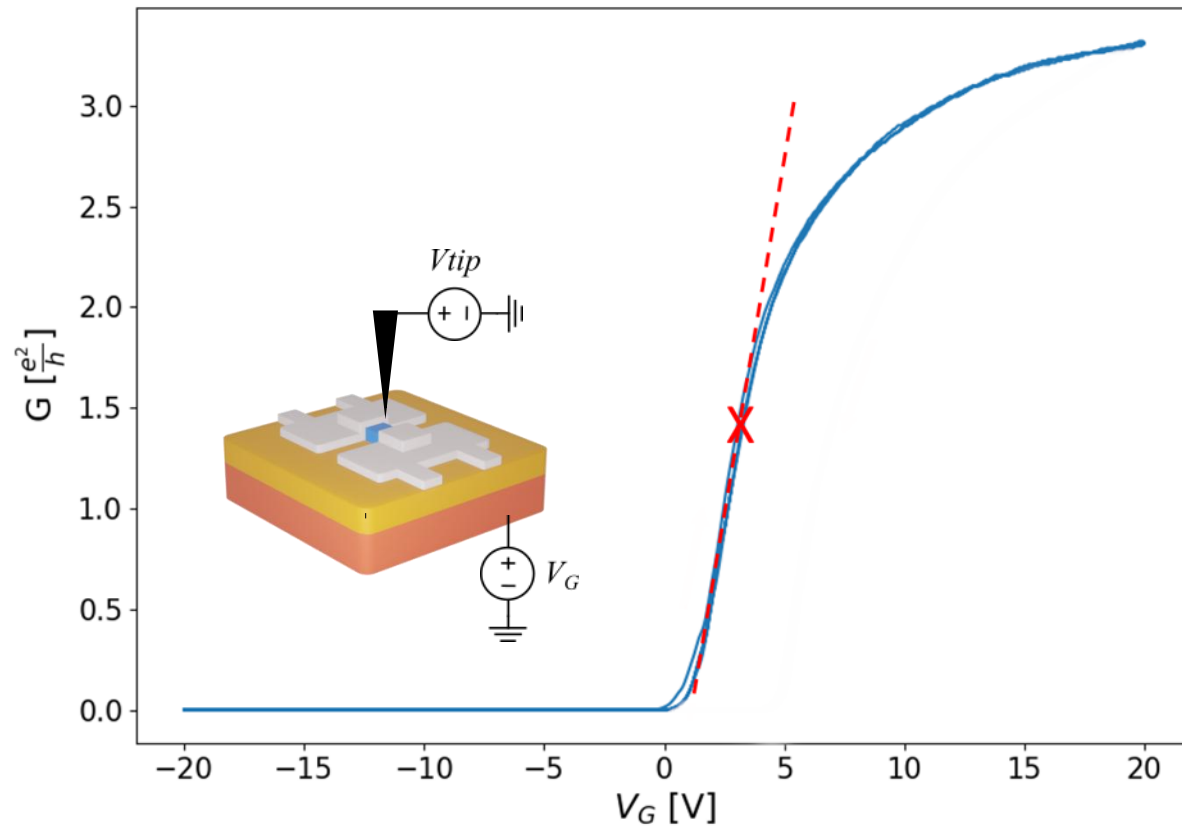
- Random drop-casting on pre-patterned Si(100) p++ substrate with 280 nm SiO₂ as dielectric
- Selected nanoflags position determined by SEM
- Leads patterning by Electron Beam Litography
- Surface passivation: 1 min in 1:9 (NH₄)₂S_x at 40°C
- Metal deposition by sputtering (Nb)



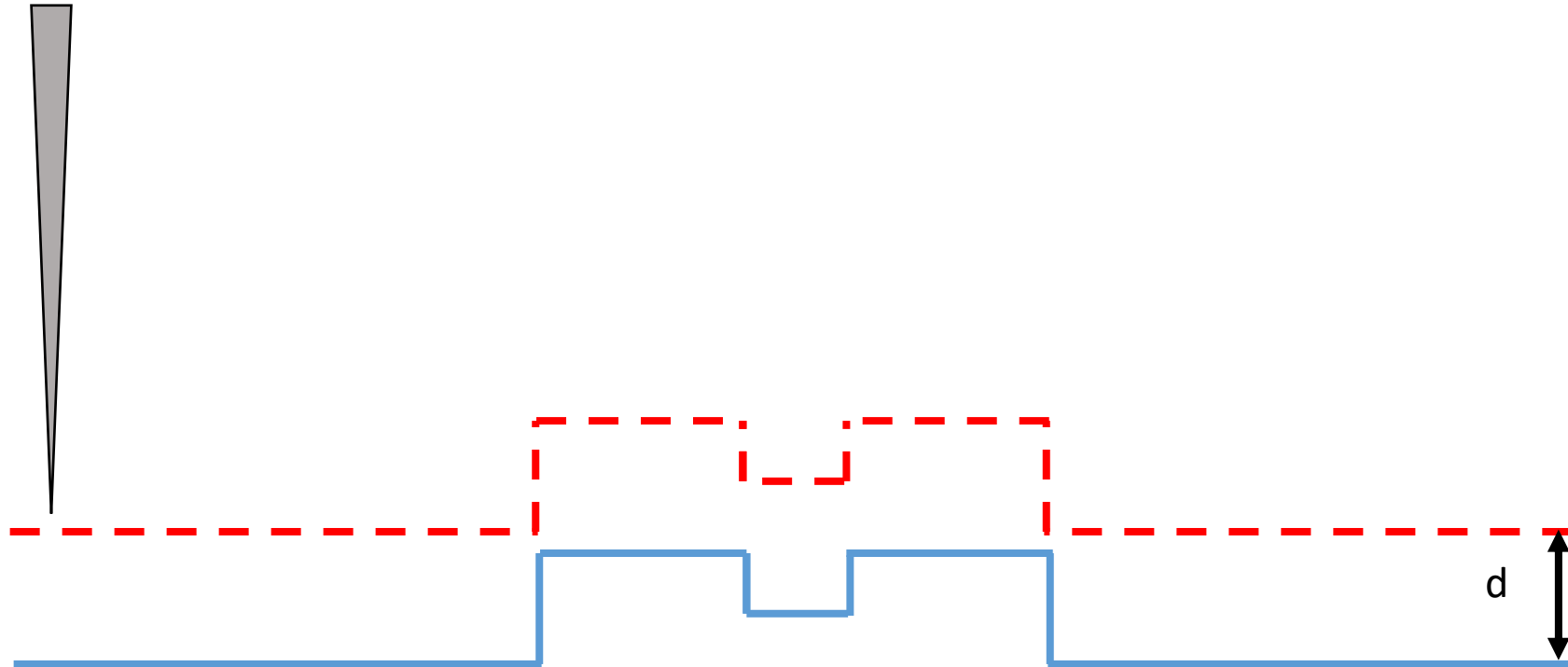
Room temperature topography maps



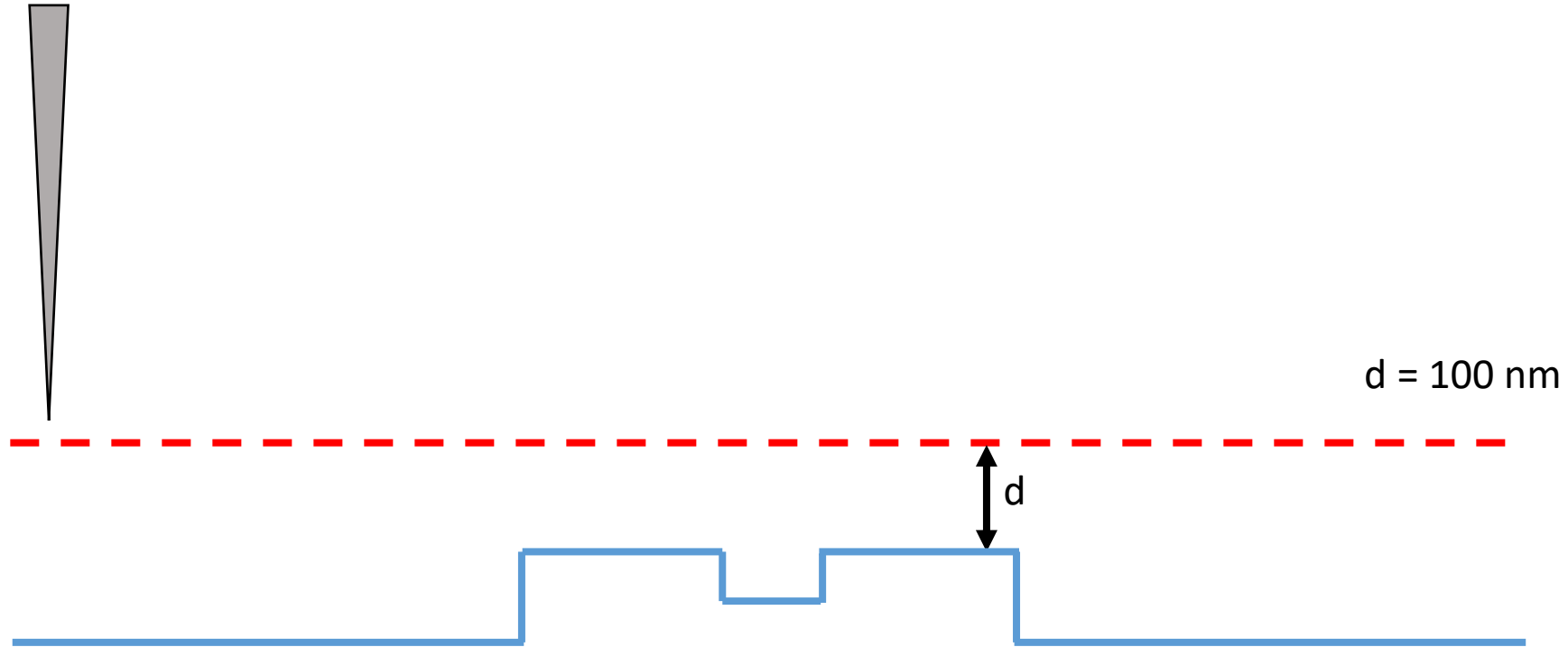
Scanning Gate Microscopy 77K



Dual Pass Mode

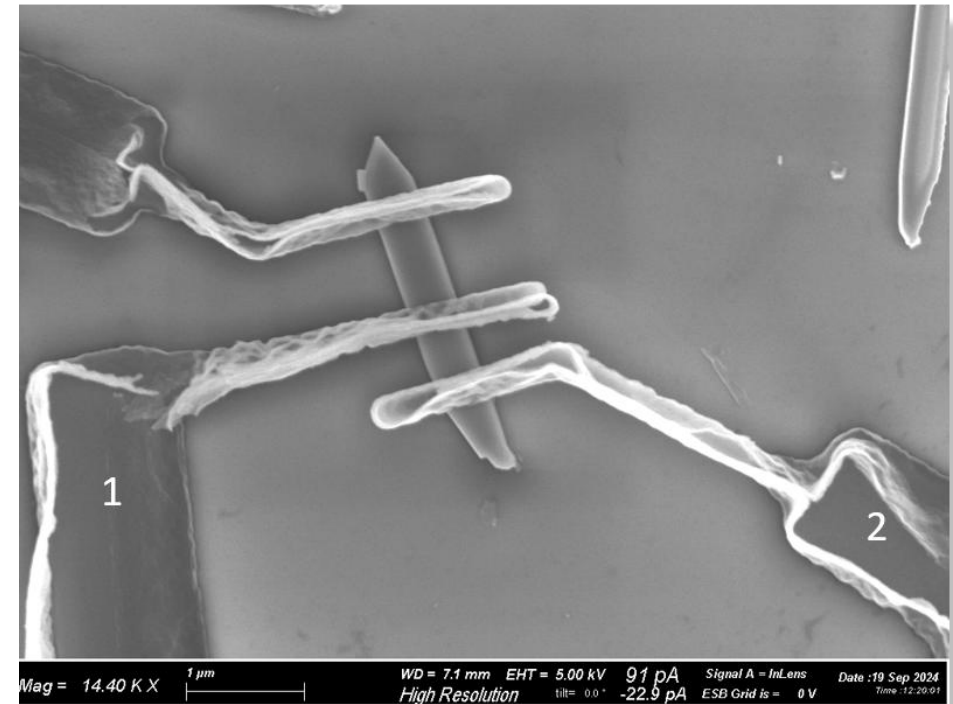
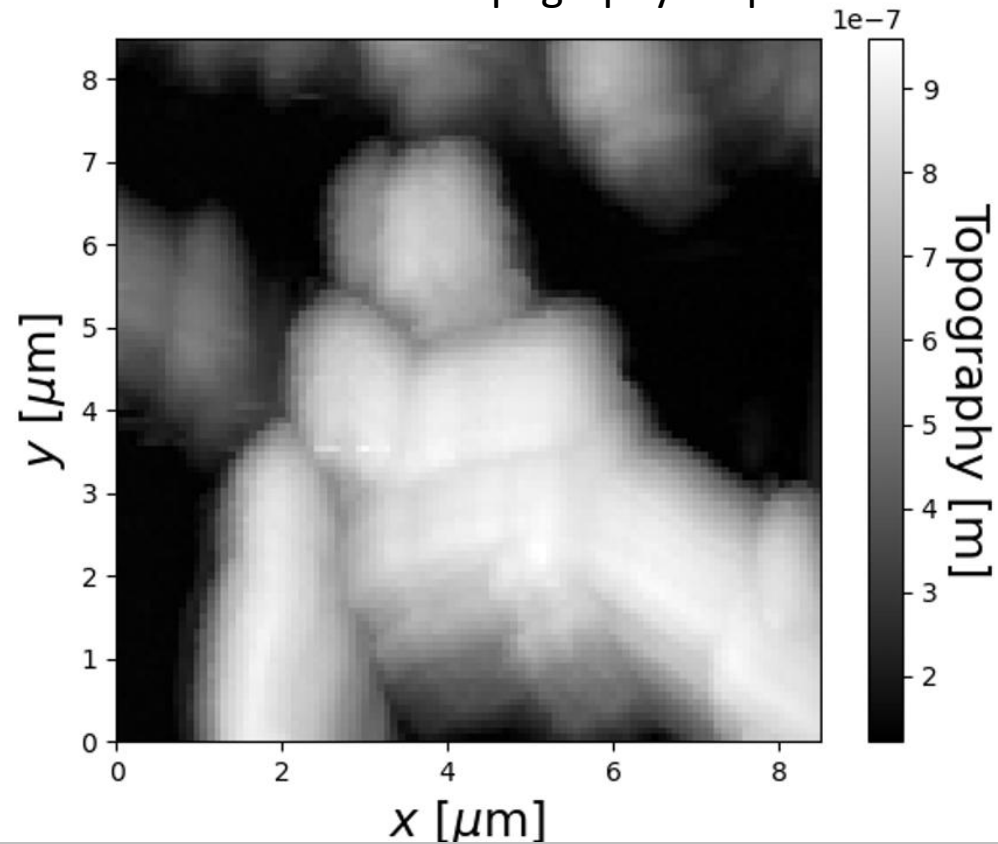


Flying Mode



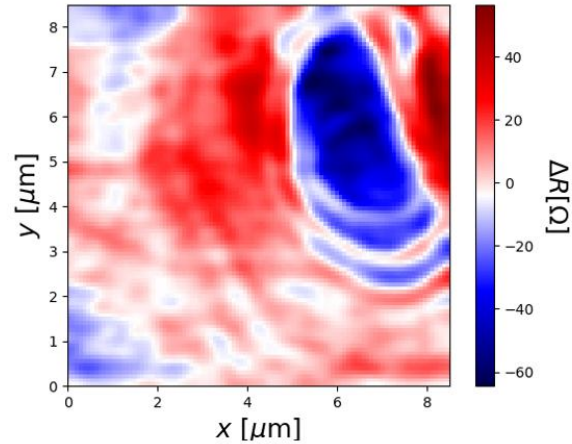
Device SC7 @300 mK

300 mK topography map

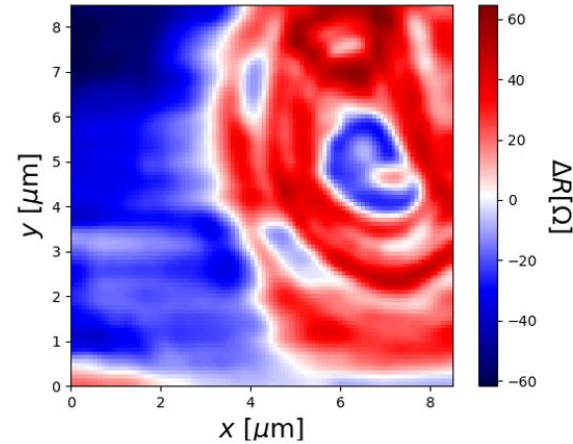


Coulomb blockade imaging by SGM

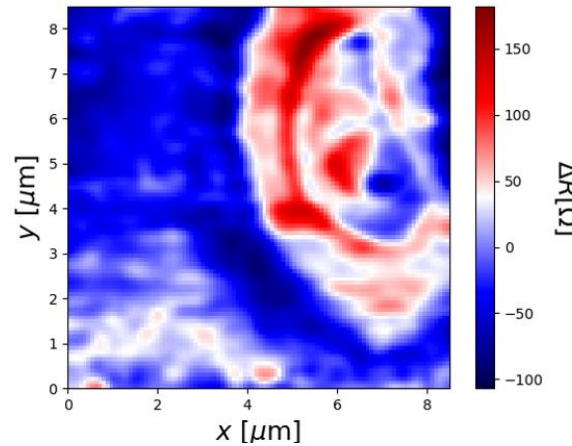
10V backgate voltage



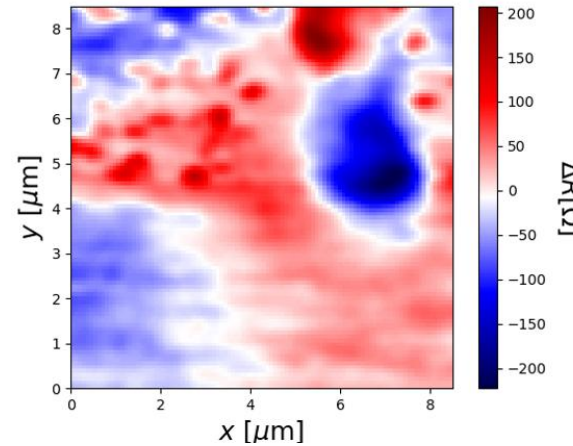
8V backgate voltage



-10V on the tip
Disorder induced quantum dots
Rings-like features
corresponding to Coulomb
blockade transitions

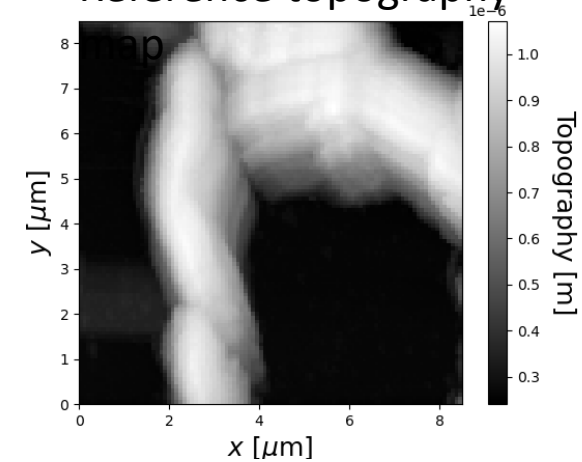


6V backgate voltage

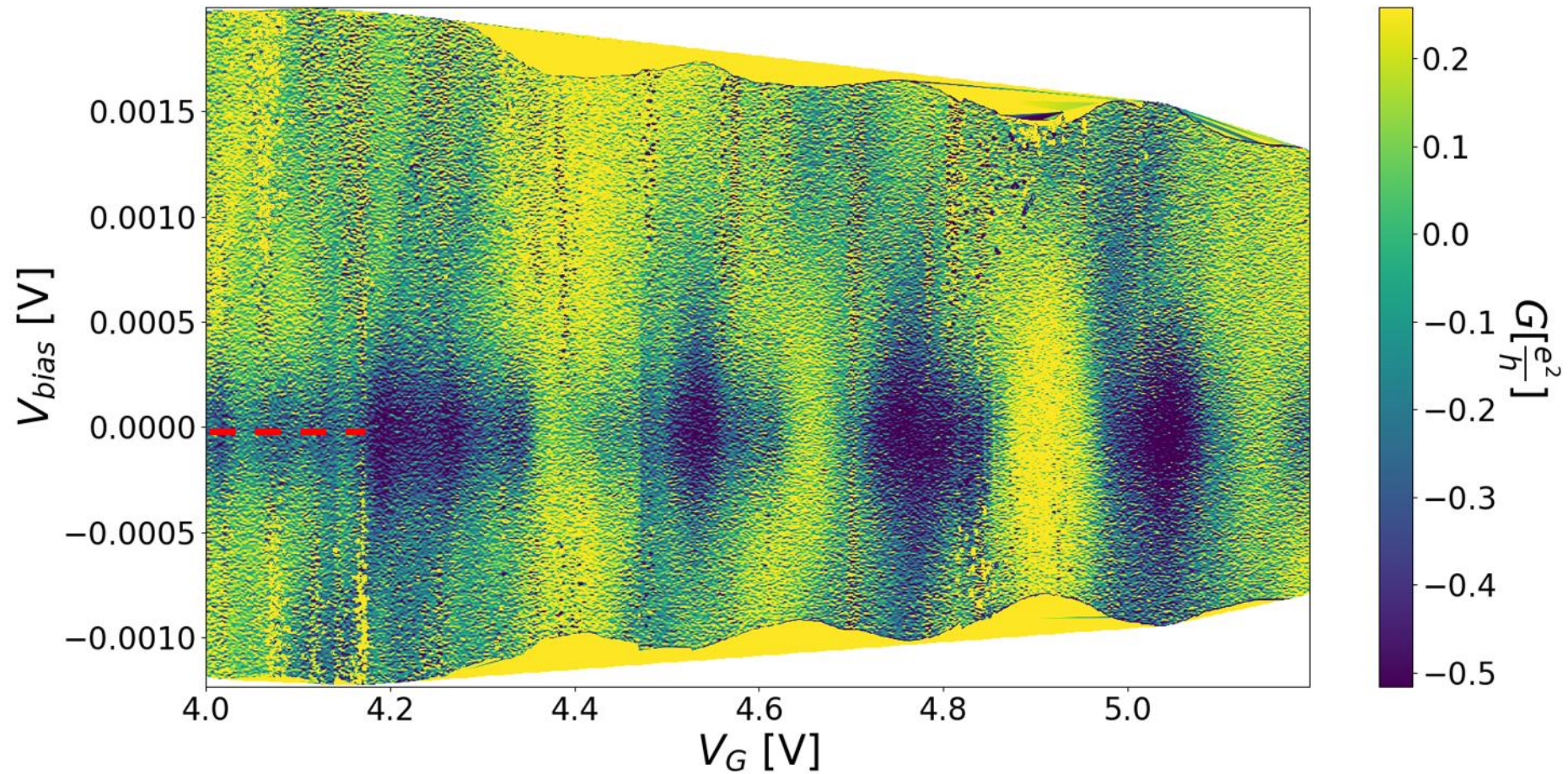


4V backgate voltage

Reference topography



Hints of Coulomb diamonds

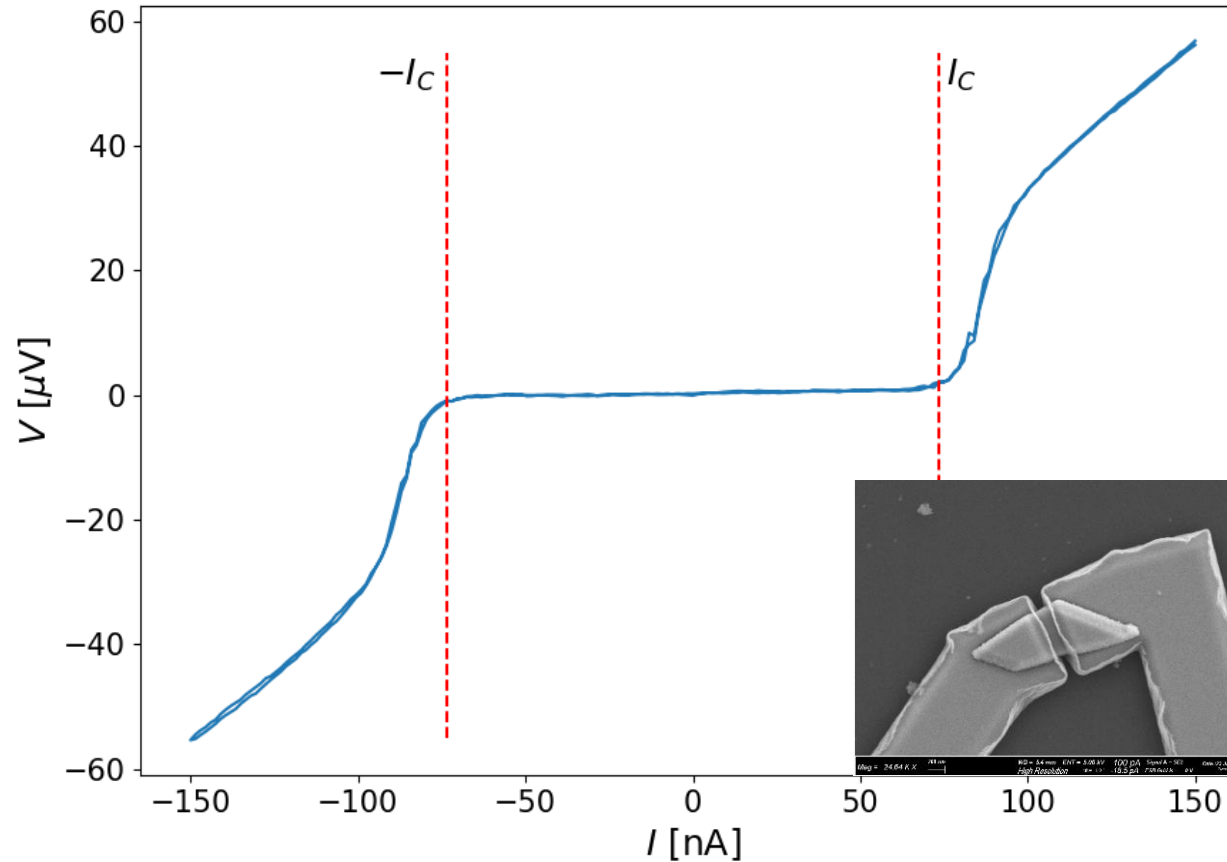


InSb nanoflag-based Josephson Junction

$T = 300 \text{ mK}$

$I_C = 73 \text{ nA}$

$V_G = 40 \text{ V}$



A new generation of devices

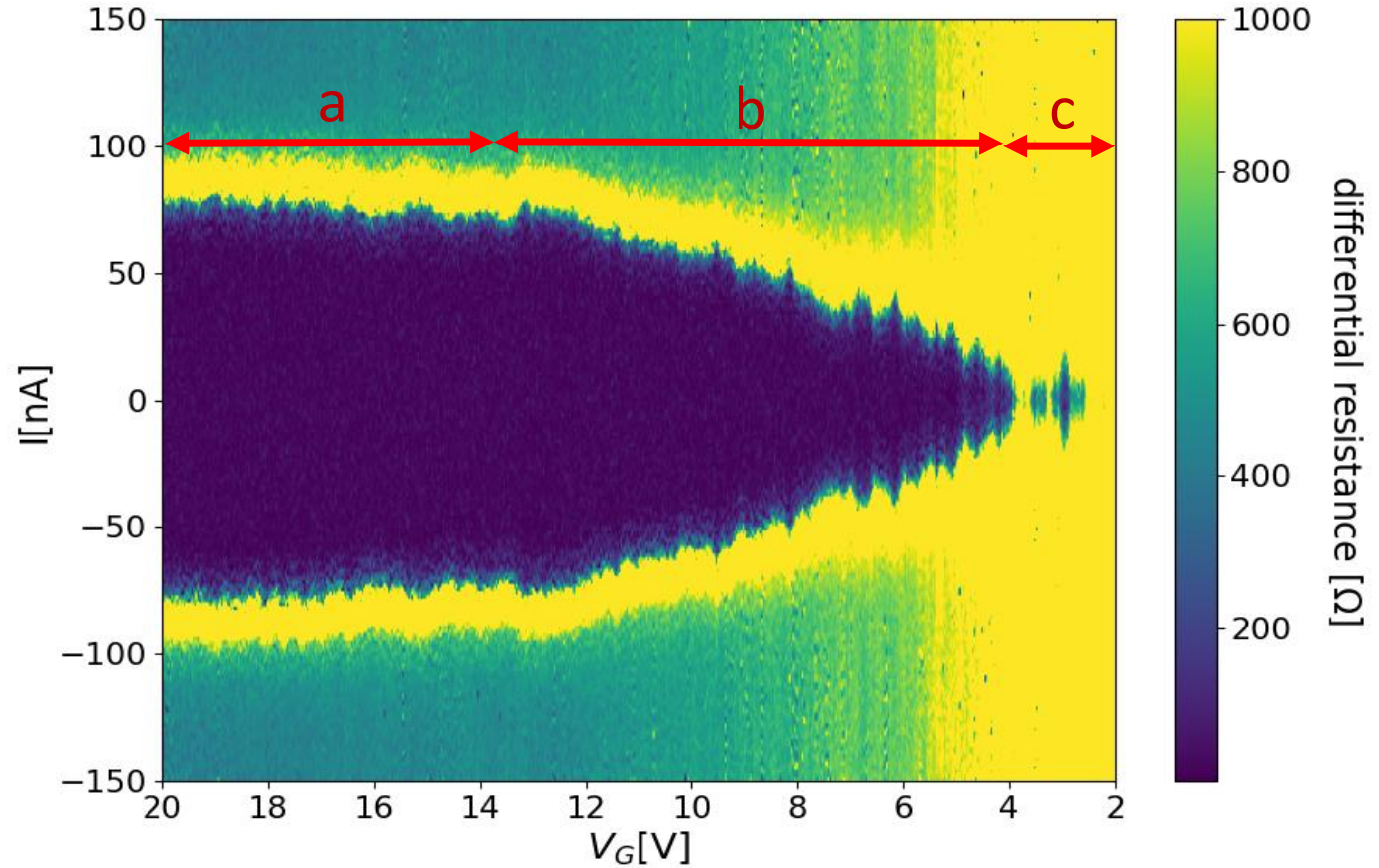
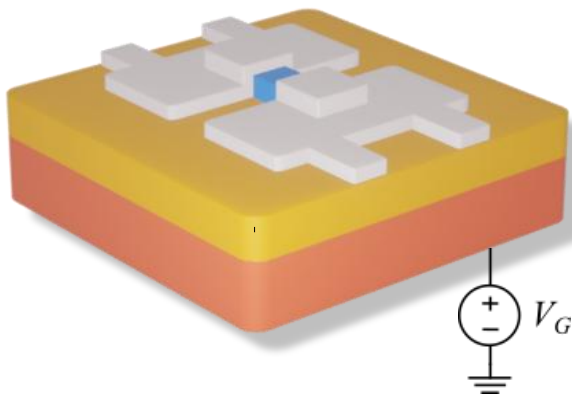
	device	L [nm]	W [nm]	I_C [nA] at $V_G = 40$ V
SGM devices	SGM ₁ D8D ₁	180 ± 10	1530 ± 30	90 ± 10
	SGM ₁ D8D ₂	130 ± 10	610 ± 10	80 ± 20
	SGM ₃ H ₄ D ₂	190 ± 10	1420 ± 30	35 ± 5
	SGM ₃ H ₅ D ₁	190 ± 10	1500 ± 30	700 ± 50
Older generation devices	SC ₁₀ [10]	200	700	50
	SC ₂₀ F6 [121]	250 ± 10	540 ± 10	50
	SC ₂₀ F7 [121]	110 ± 10	530 ± 10	17

Gate tunable supercurrent: JoFET

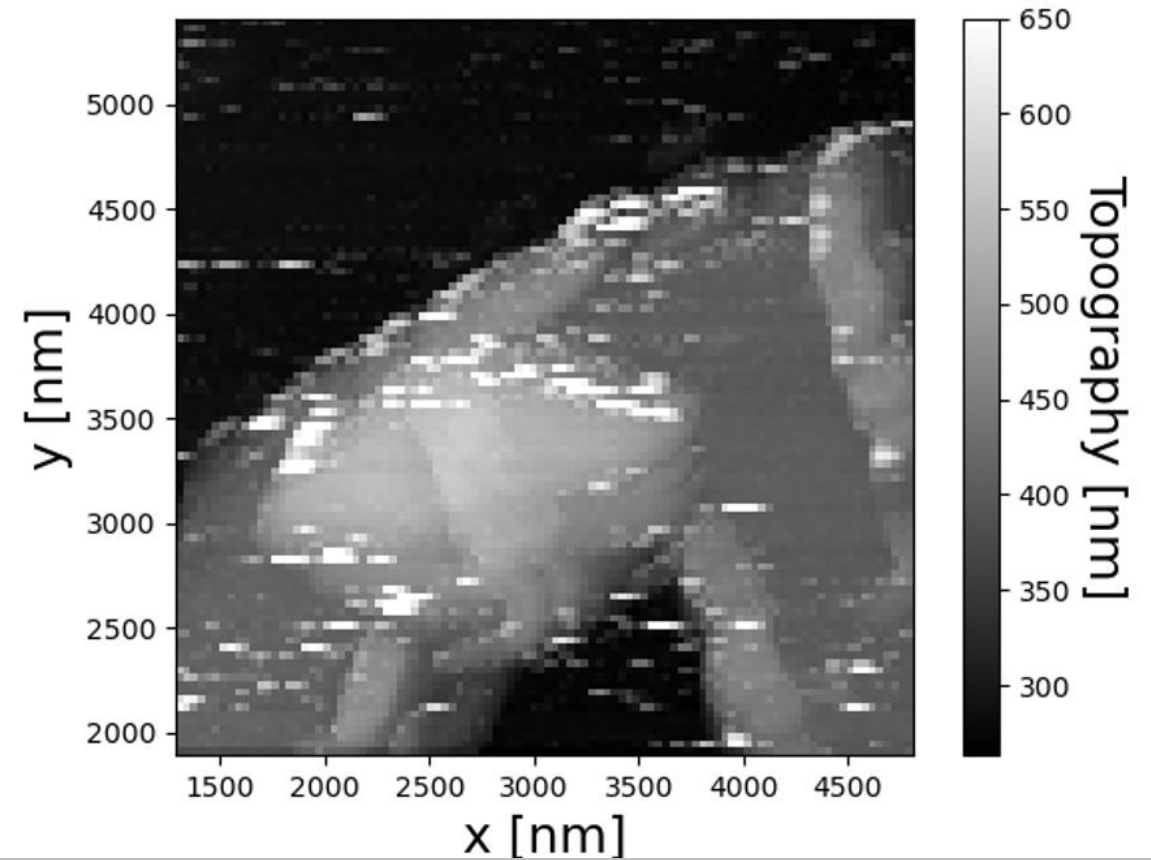
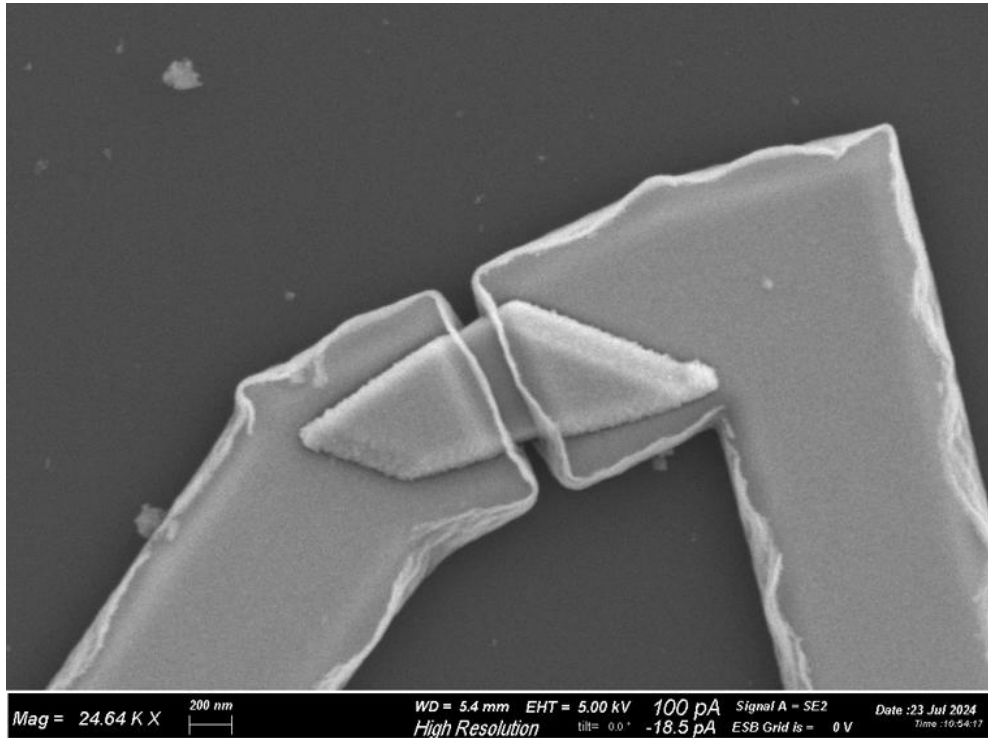
a = saturation regime

b = modulation regime

c = pinch-off regime



300 mK topography maps

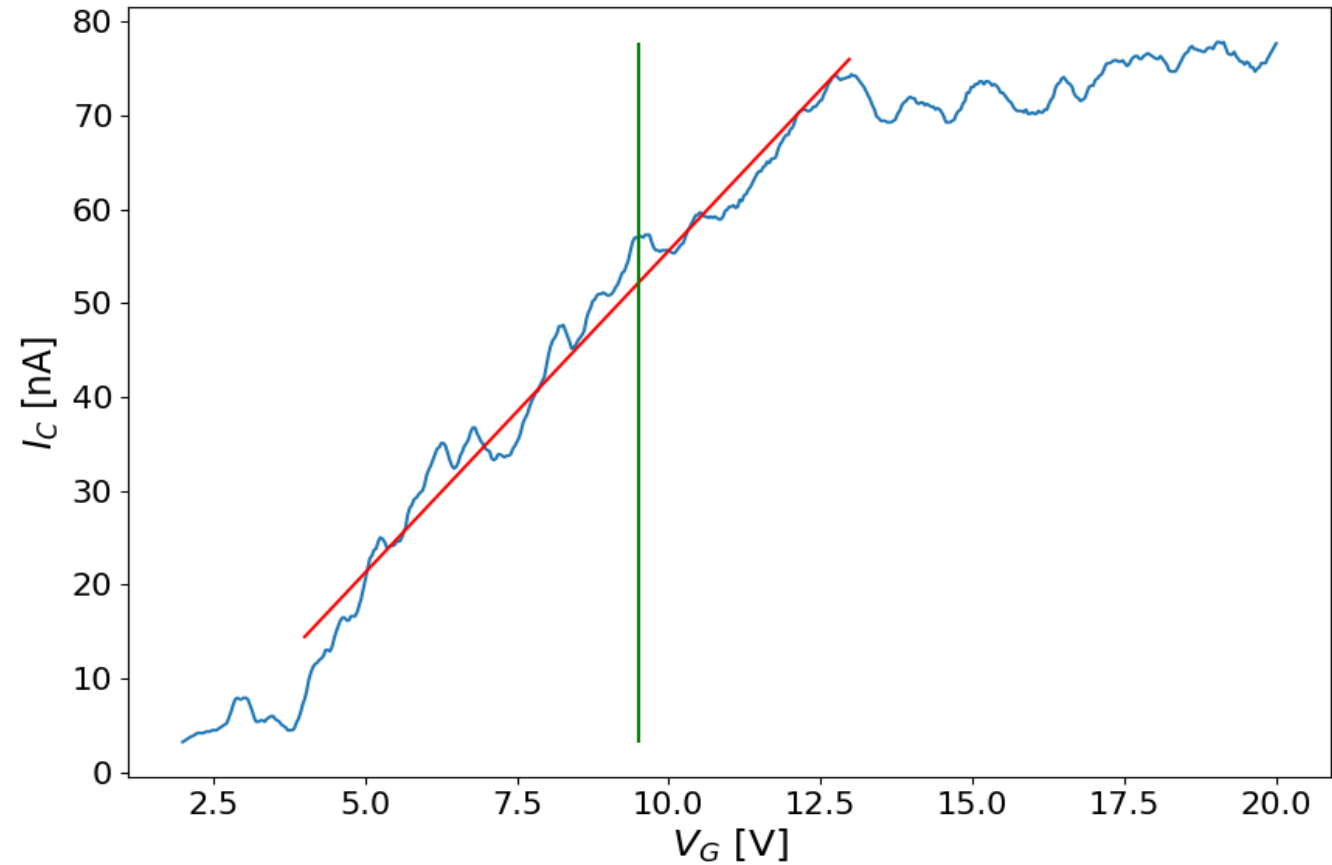
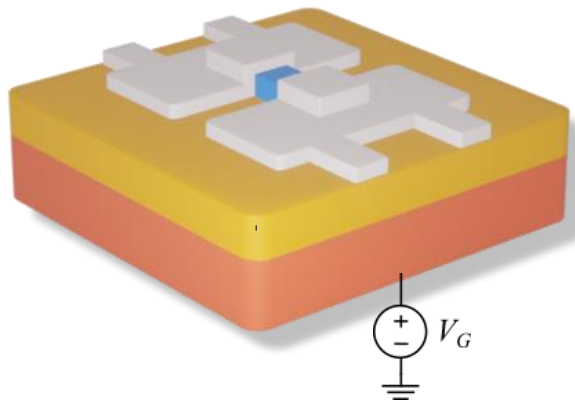


Working point

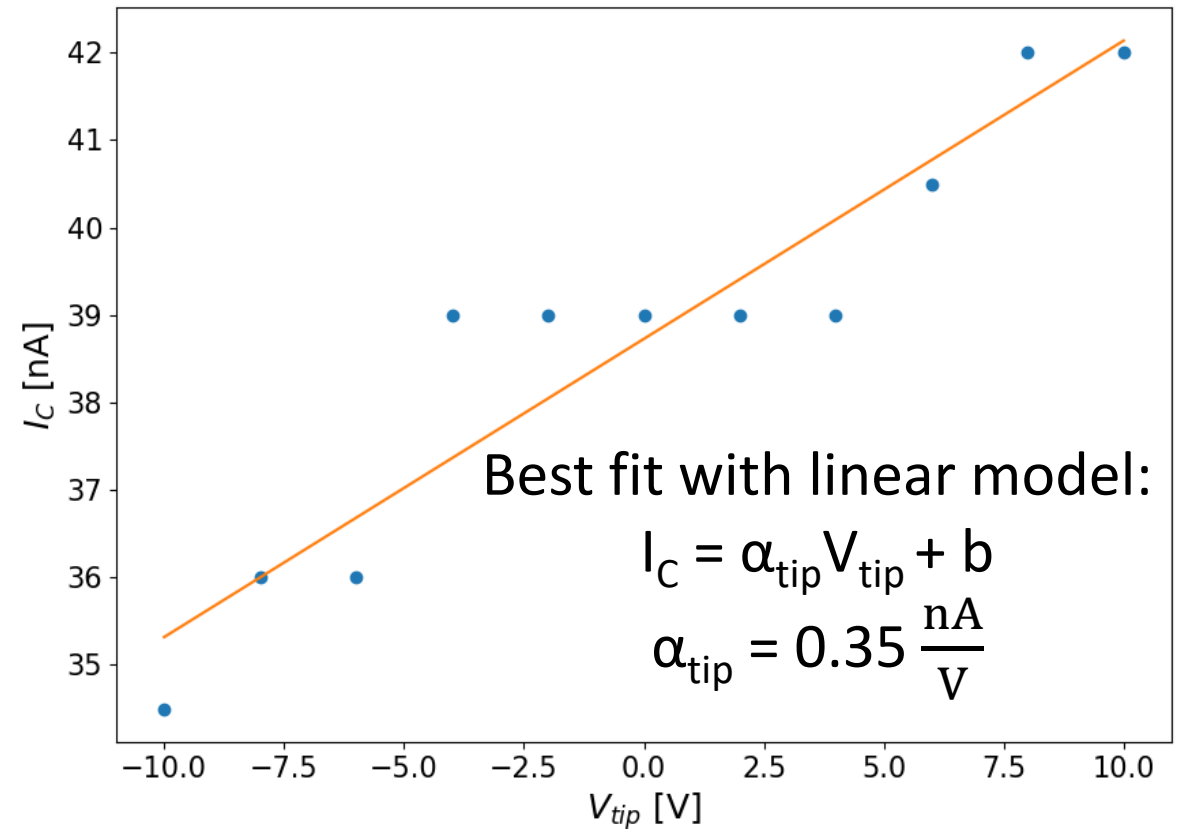
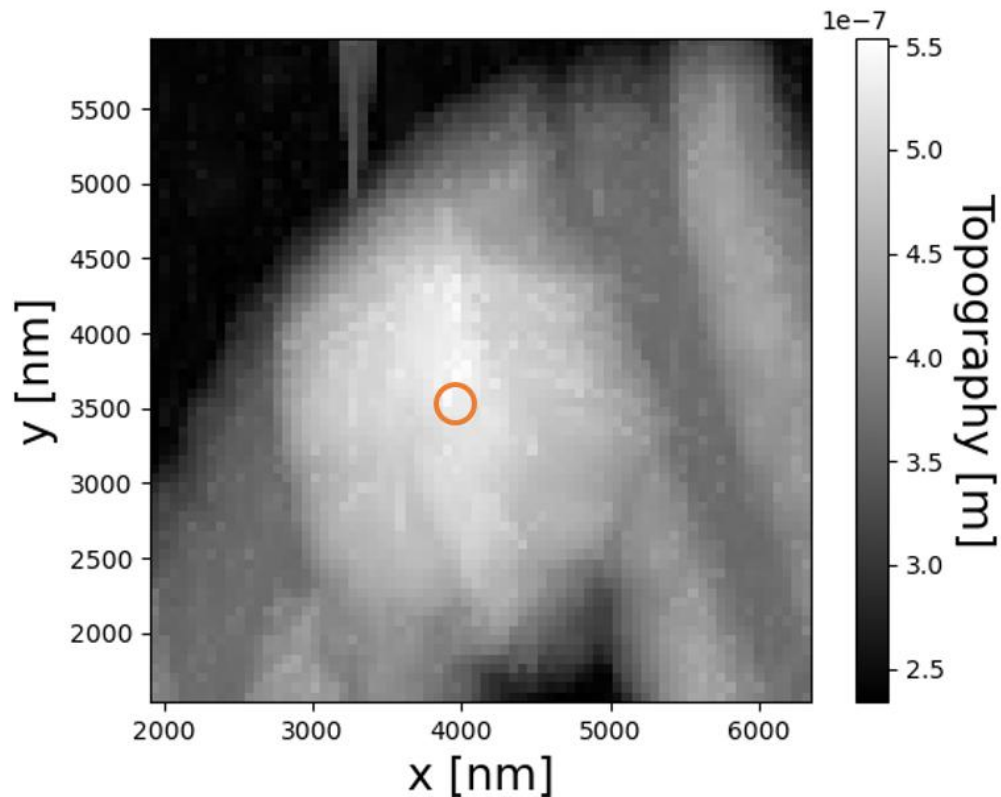
Best fit with linear model:

$$I_C = \alpha_G V_G + b$$

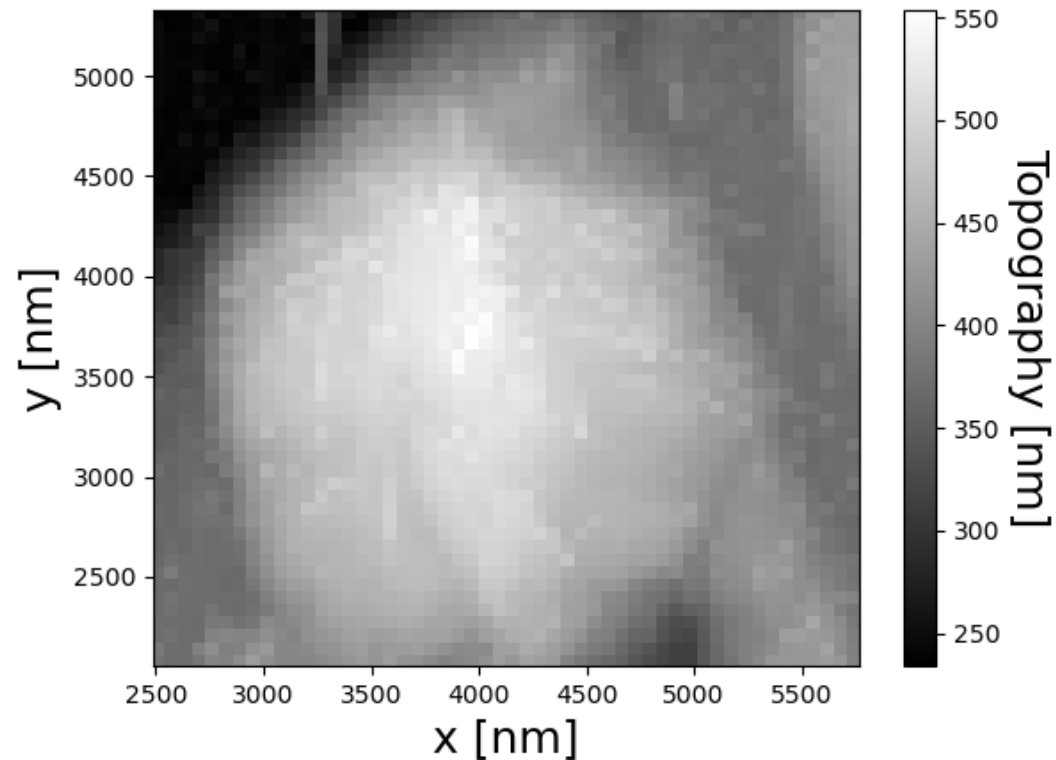
$$\alpha_G = 6.5 \frac{\text{nA}}{\text{V}}$$



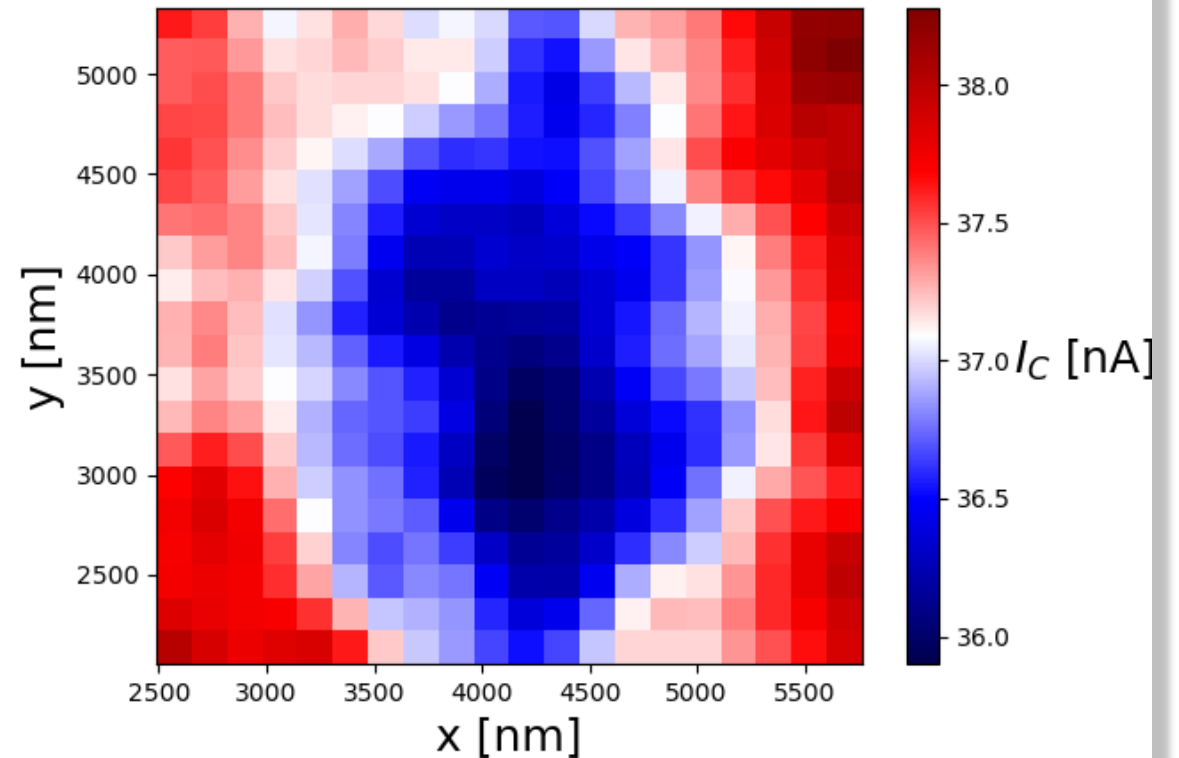
Tip-induced critical current modulation



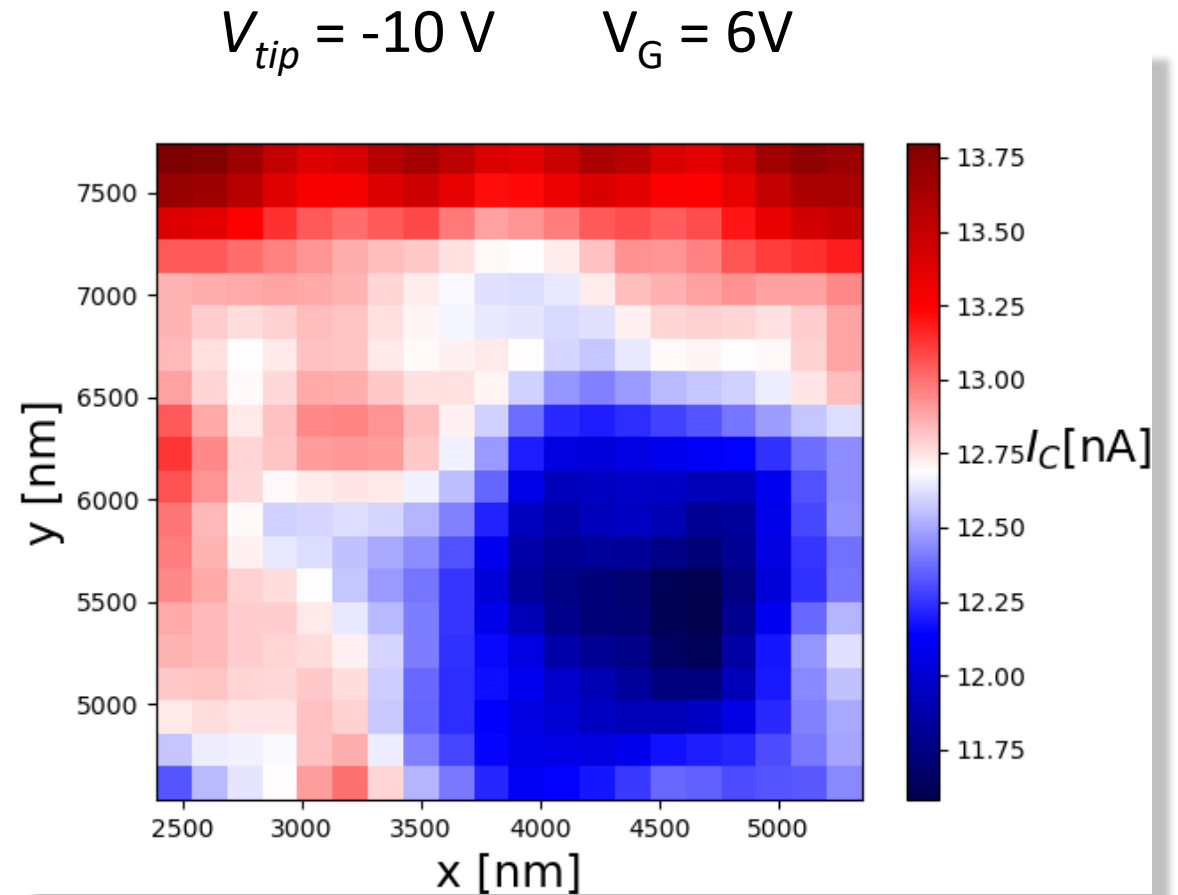
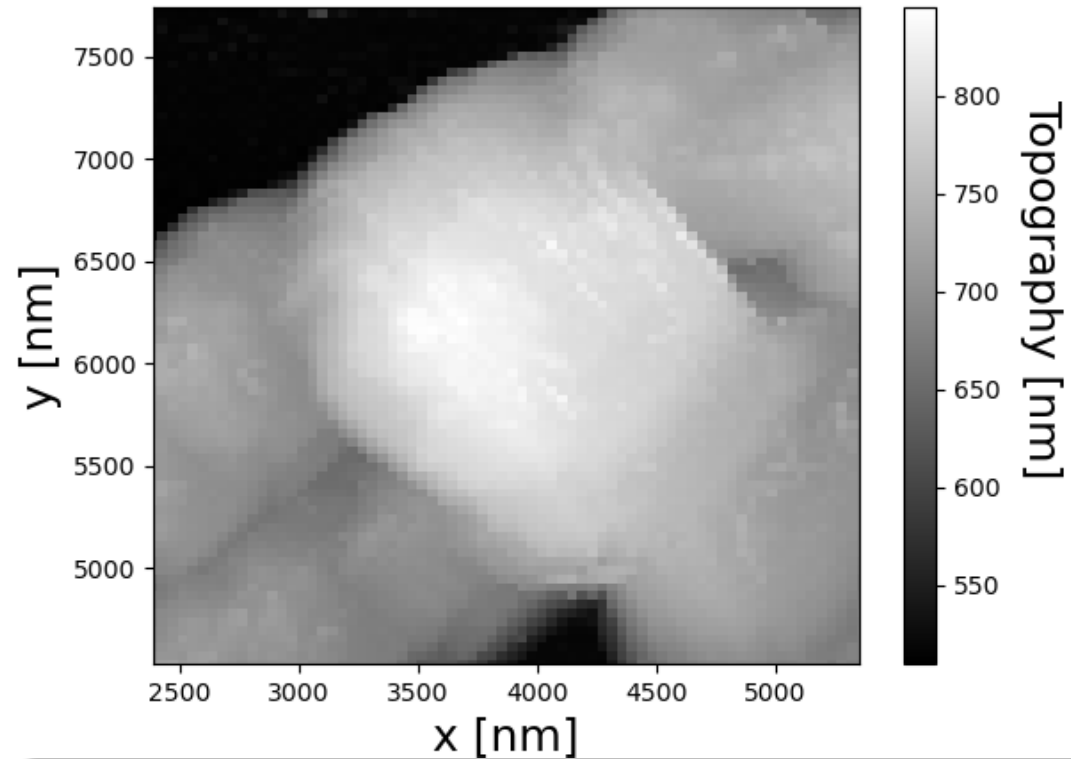
Critical current modulation by SGM



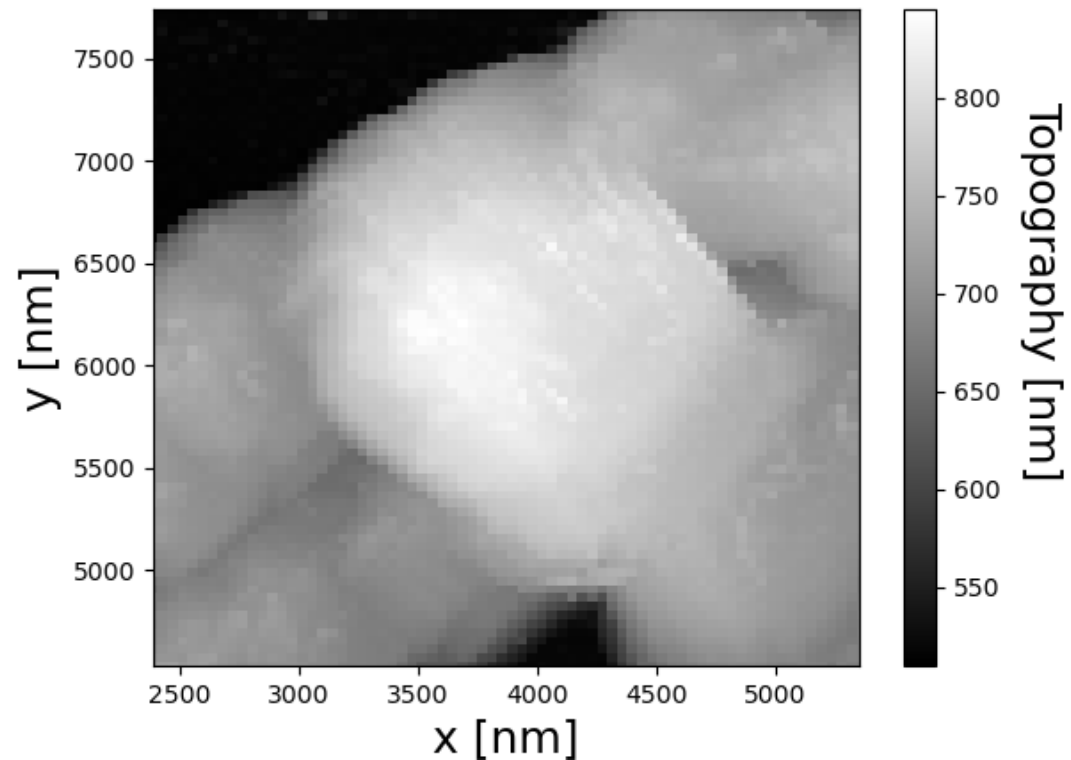
$$V_{tip} = -10 \text{ V} \quad V_G = 9.5 \text{ V}$$



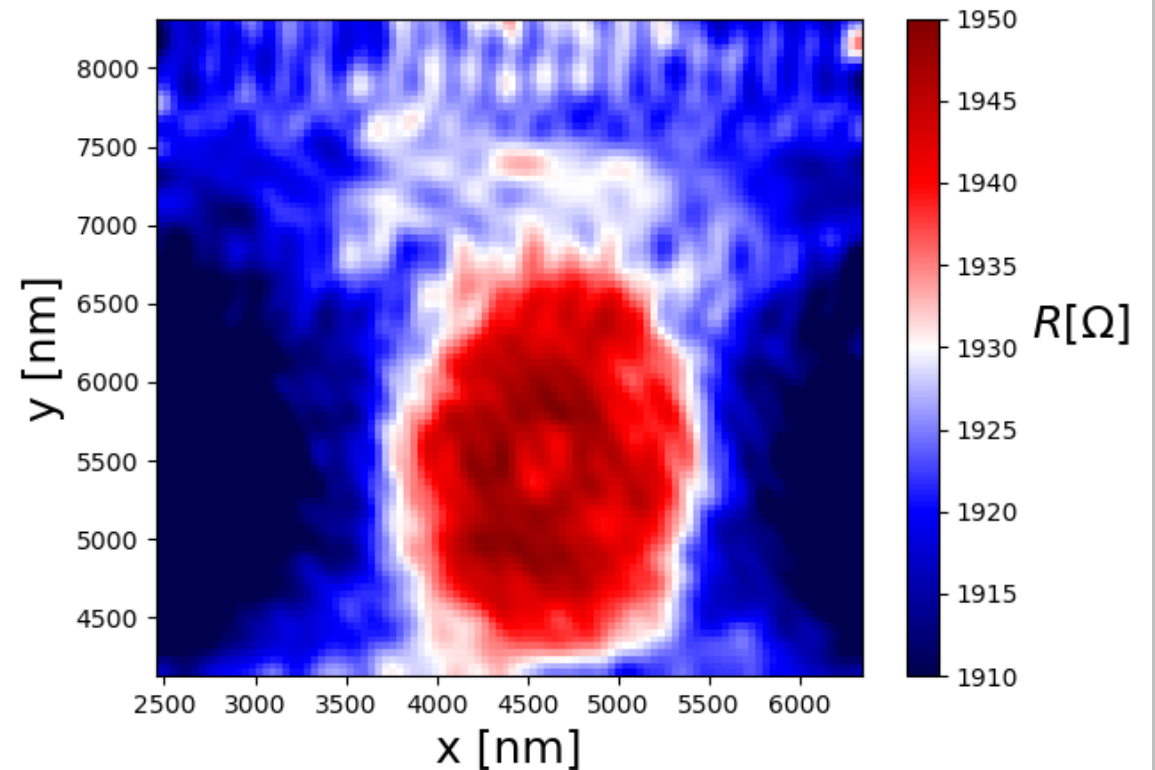
Reproducibility: device SGM3 H4D2



Conventional normal state SGM



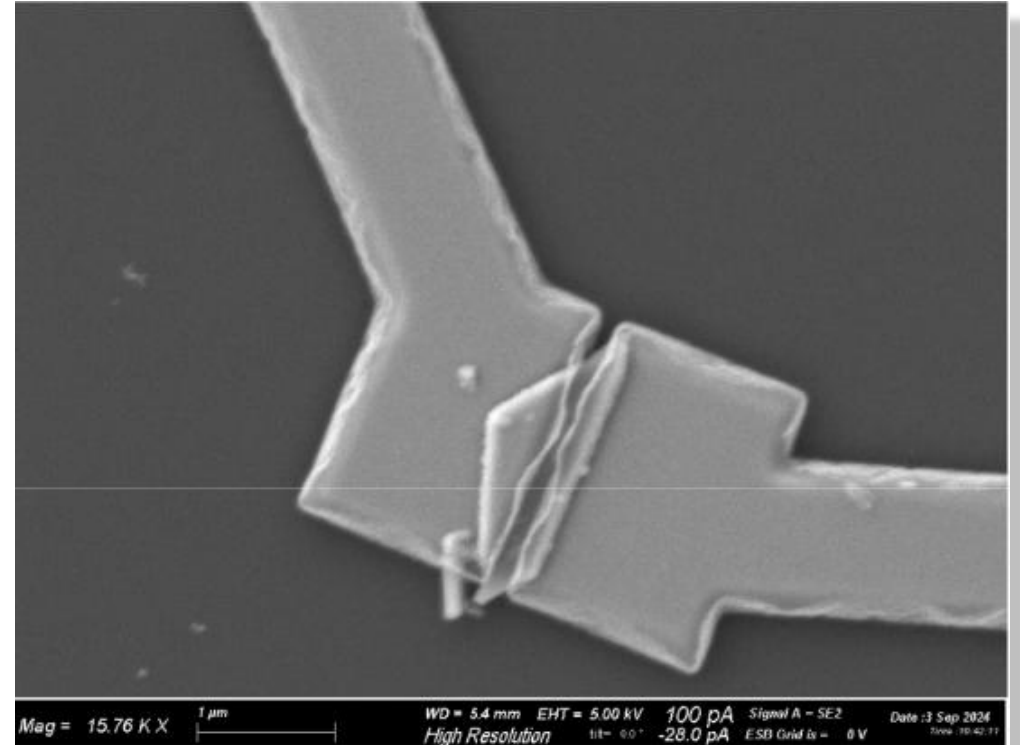
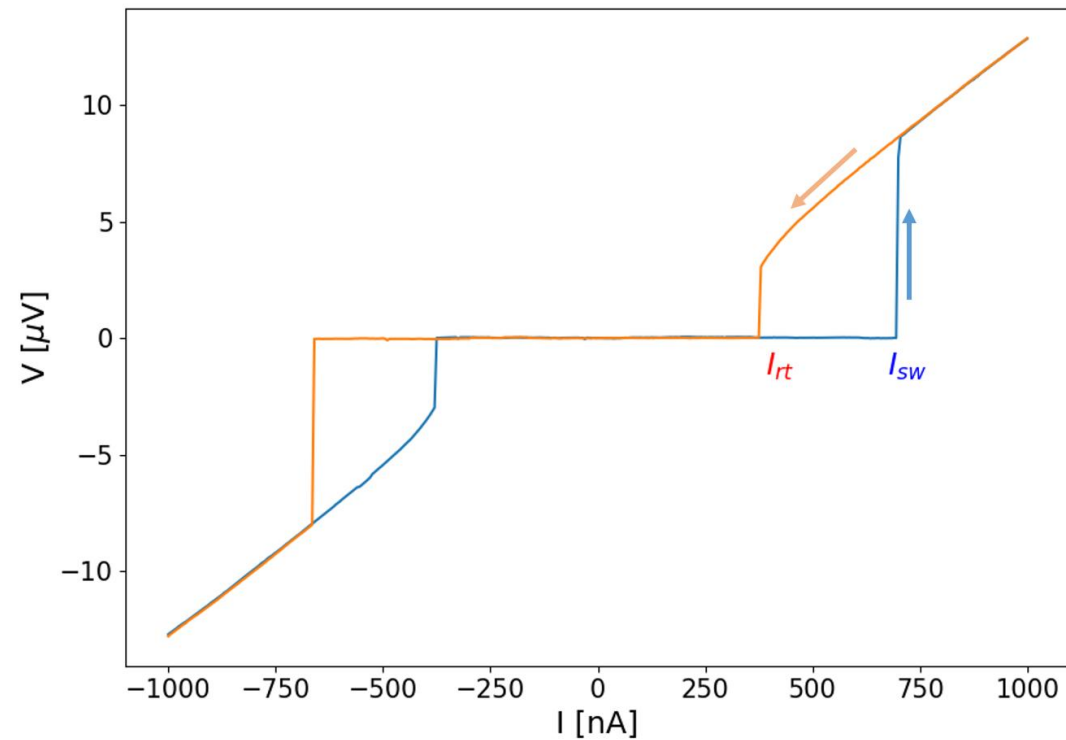
$$V_{tip} = -10 \text{ V} \quad V_G = 1.5 \text{ V}$$



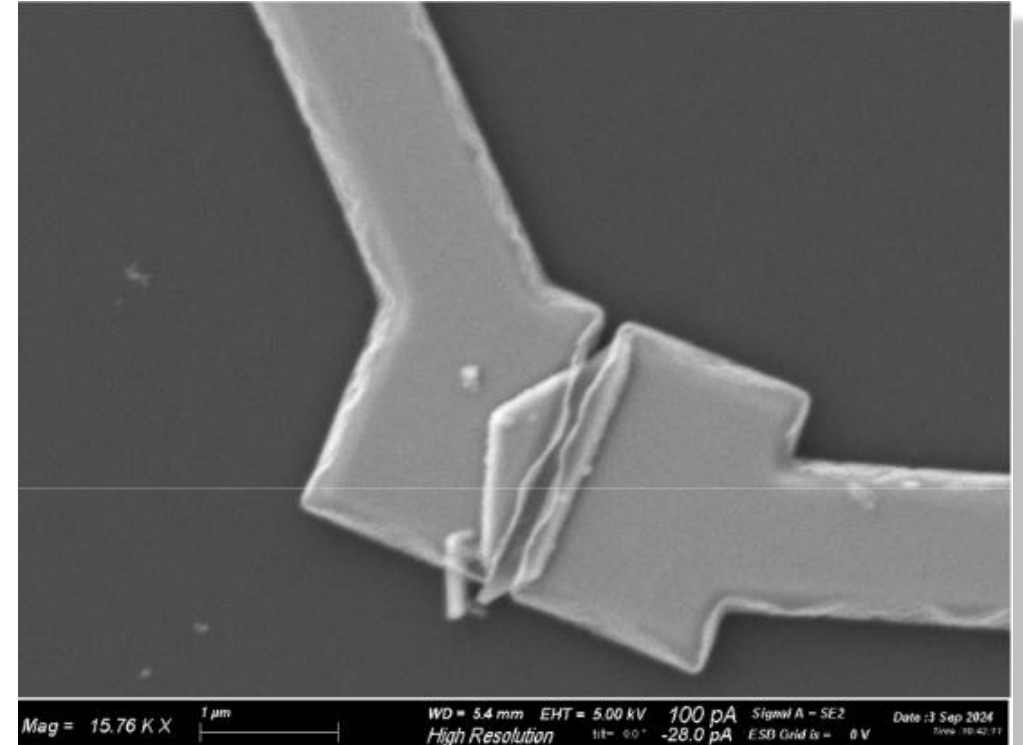
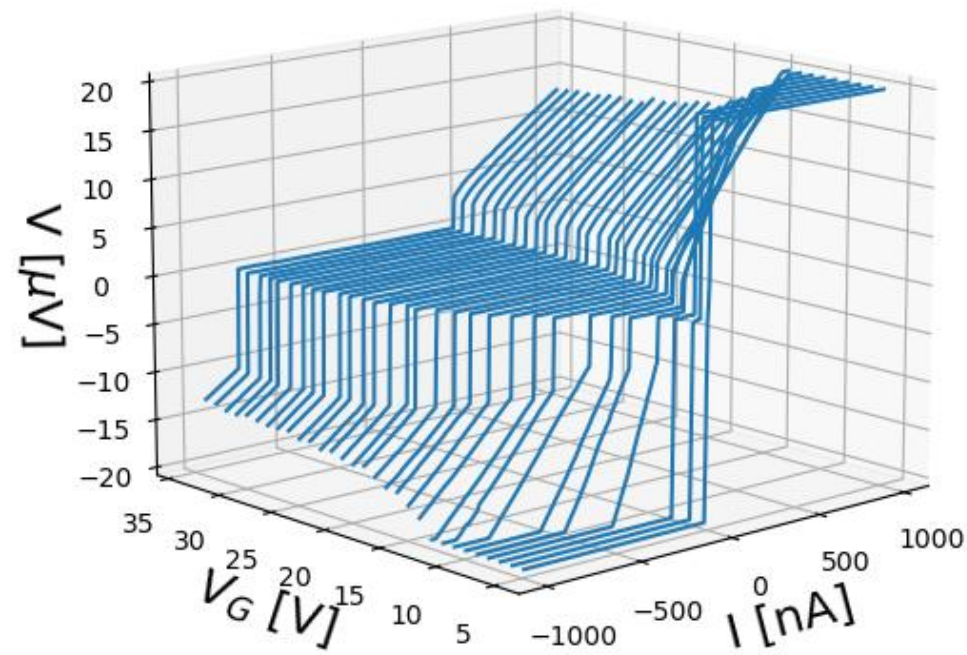
Device SGM H5D1

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An interesting outlier



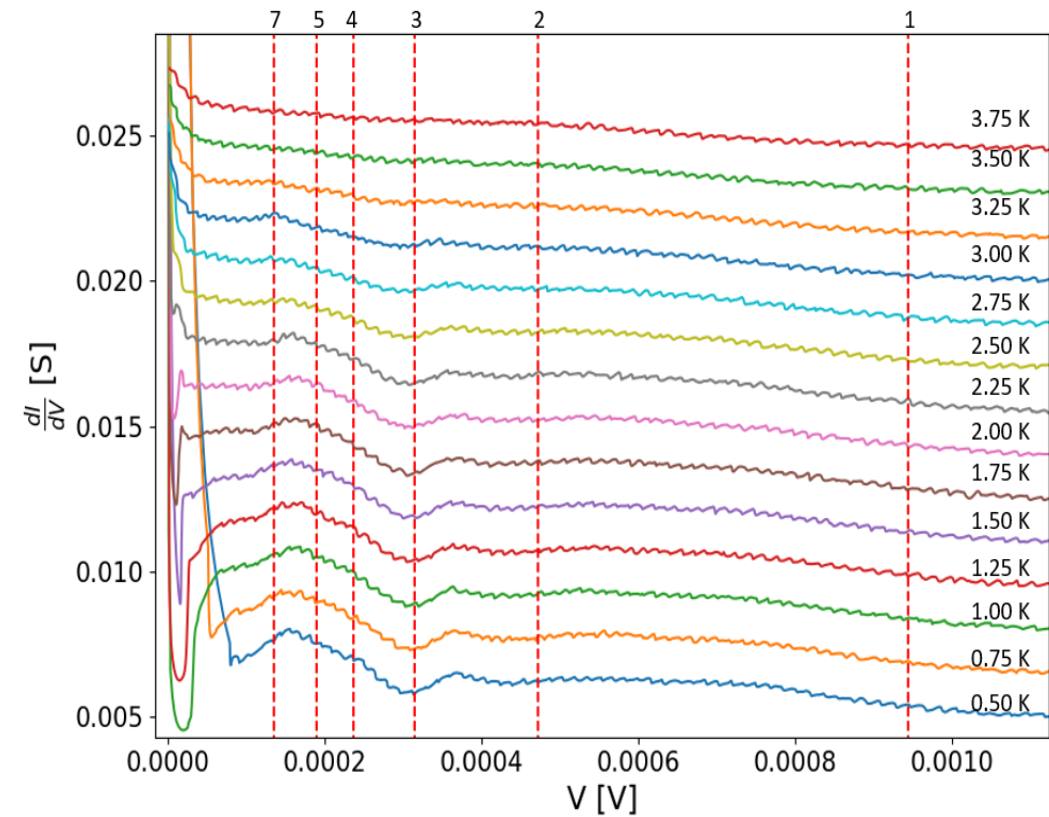
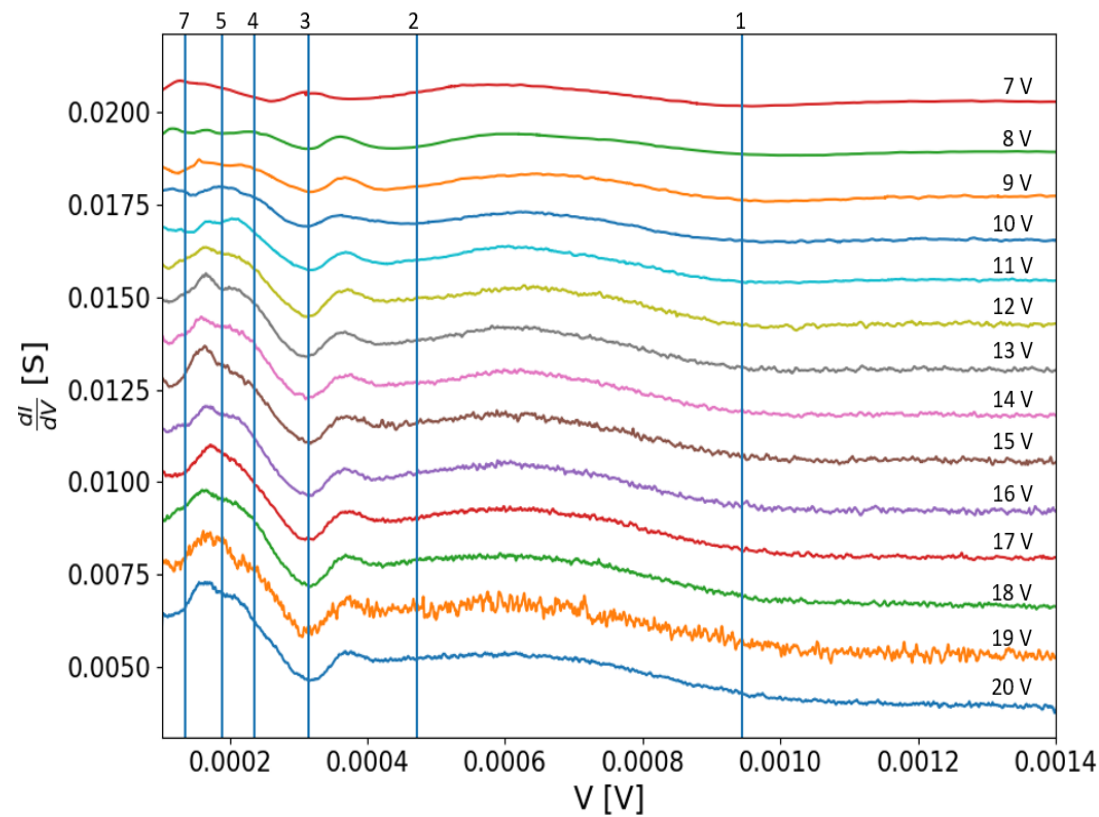
An interesting outlier



Multiple Andreev reflections

$\Delta' = 460 \mu\text{eV}$ (from third AR)
Corresponding $\gamma_B = 3.28$

$$\Delta^*(T) = \frac{\Delta(T)}{1 + \frac{\gamma_B}{\pi T_C} \sqrt{\Delta^2(T) - \Delta^{*2}(T)}}$$



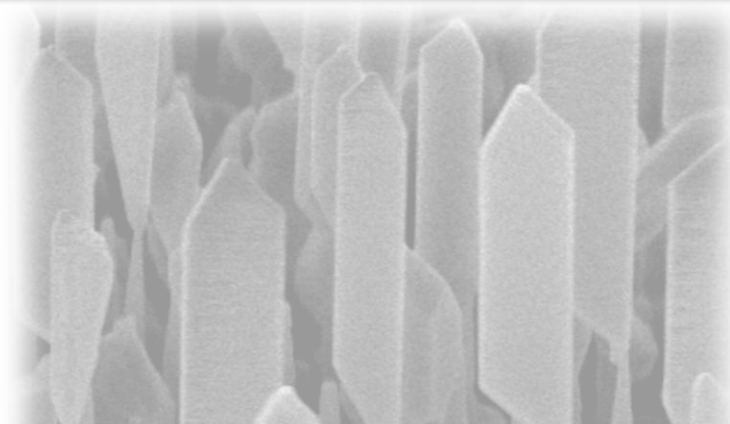
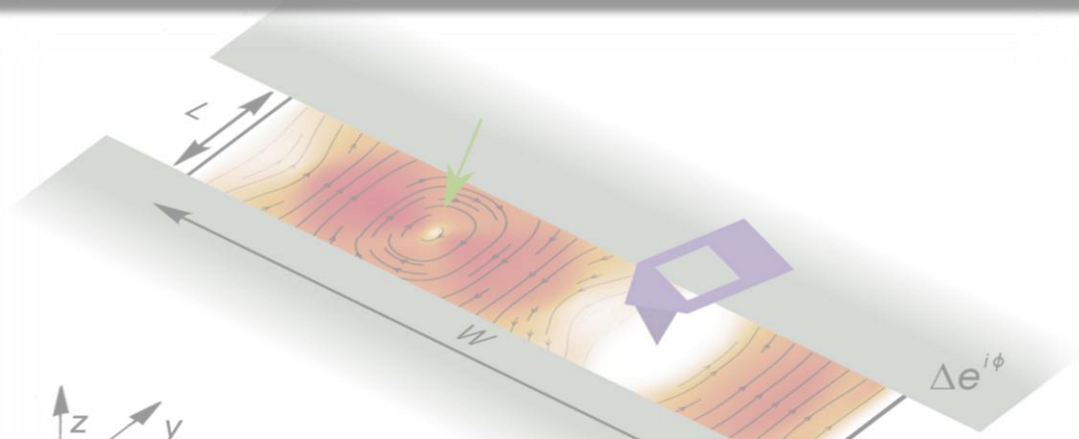
Sum up

- First SGM maps of InSb nanoflag-based devices
- First measurements of tip-induced critical current modulation
- Observation of high interface transparency for InSb nanoflag-based devices

Current goals

- Increase spatial resolution and signal to noise ratio
- Reduce tip-device distance
- Overcome tip-to-device discharge issues
- Investigate devices with higher switching currents by SGM

We are currently experimenting on depositing thin layers of high performance dielectric (HfO_2) on the region of interest



Thank you!

